TE Internal #: 1470364-4

Housing, Receptacle, Wire-to-Board, 4 Position, 1 mm [.039 in] Centerline, Crimp, 1 Row, White, Wire & Cable, Power & Signal

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Connector Product Type: Housing

Connector & Housing Type: Receptacle

Connector System: Wire-to-Board

Number of Positions: 4

Centerline (Pitch): 1 mm [.039 in]

All AMP HPI 1.0MM RECEPTACLE HOUSINGS (15)

Features

Product Type Features

Connector Product Type	Housing
Connector & Housing Type	Receptacle
Connector System	Wire-to-Board
Sealable	No
Connector & Contact Terminates To	Wire & Cable
Configuration Features	
Number of Positions	4
Number of Rows	1
Electrical Characteristics	
Operating Voltage	50 VAC
Contact Features	
Contact Layout	Inline

Socket

Contact Type



Contact Current Rating (Max)	1 A
Termination Features	
Termination Method to Wire & Cable	Crimp
Mechanical Attachment	
Strain Relief	Without
Panel Mount Feature	Without
PCB Mount Retention	Without
Mating Retention	Without
Connector Mounting Type	Cable Mount (Free-Hanging)
Housing Features	
Housing Entry Configuration	Both Ends Closed
Housing Material	Thermoplastic
Centerline (Pitch)	1 mm[.039 in]
Housing Color	White
Dimensions	
Connector Length	7 mm[.276 in]
Connector Height	2.8 mm[.11 in]
Connector Width	5 mm[.197 in]
Wire Size	32 – 28 AWG
Usage Conditions	
Operating Temperature Range	55 – 105 °C[131 – 221 °F]
Operation/Application	
Circuit Application	Power & Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	32000
Packaging Method	Bag

Product Compliance

For compliance documentation, visit the product page on TE.com>



EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





Documents

Product Drawings

1.0MM W T B RECPT,4POS HOUSING

English

CAD Files

3D PDF

3D

Customer View Model



ENG_CVM_CVM_1470364-4_R_c-1470364-4-r.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1470364-4_R_c-1470364-4-r.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1470364-4_R_c-1470364-4-r.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

HPI Connectors QRG

English

Product Specifications

Application Specification

English